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Part Number: [87831-3020](#)
Status: **Active**
Overview: [Milli-Grid™ Connector System](#)
Description: 2.00mm Pitch Milli-Grid™ Header, Vertical, Through Hole, Shrouded, Lead-Free, 30 Circuits, 0.38µm Gold (Au) Plating, Center Polarization Slot, with Locking Windows, without PCB Locator, Tube

Documents:

[3D Model](#) [Product Specification PS-87831-027 \(PDF\)](#)
[Drawing \(PDF\)](#) [RoHS Certificate of Compliance \(PDF\)](#)

Agency Certification

CSA LR19980
 UL E29179

General

Product Family PCB Headers
 Series [87831](#)
 Application Signal, Wire-to-Board
 Comments Contact Molex for application in automotive industry
 MolexKits Yes
 Overview [Milli-Grid™ Connector System](#)
 Product Name Milli-Grid™
 UPC 822348274185

Physical

Breakaway No
 Circuits (Loaded) 30
 Circuits (maximum) 30
 Color - Resin Black
 Durability (mating cycles max) 100
 First Mate / Last Break No
 Flammability 94V-0
 Glow-Wire Compliant No
 Guide to Mating Part No
 Keying to Mating Part None
 Lock to Mating Part Yes
 Material - Metal Phosphor Bronze
 Material - Plating Mating Gold
 Material - Plating Termination Tin
 Material - Resin Nylon
 Net Weight 1.332/g
 Number of Rows 2
 Orientation Vertical
 PC Tail Length 2.50mm
 PCB Locator No
 PCB Retention None
 PCB Thickness - Recommended 1.60mm
 Packaging Type Tube
 Pitch - Mating Interface 2.00mm
 Pitch - Termination Interface 2.00mm
 Plating min - Mating 0.381µm
 Plating min - Termination 1.905µm
 Polarized to PCB No
 Shrouded Yes
 Stackable No



EU RoHS

ELV and RoHS Compliant

REACH SVHC

Not Reviewed

Low-Halogen Status

Not Low-Halogen

China RoHS



Need more information on product environmental compliance?

Email productcompliance@molex.com
 For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series

[87831Series](#)

Mates With

[50394](#) Wire-to-Board Terminals, [51110](#) Wire-to-Board Crimp Housing, [87568](#) Wire-to-Board IDT Housings, [79107](#) Board-to-Board Top Entry Through Hole Receptacle, [79108](#) Board-to-Board FFC/FPC Top Entry Through Hole Receptacle

| | |
|--------------------------------|-----------------|
| Surface Mount Compatible (SMC) | Yes |
| Temperature Range - Operating | -55°C to +105°C |
| Termination Interface: Style | Through Hole |

Electrical

| | |
|-------------------------------|------|
| Current - Maximum per Contact | 2A |
| Voltage - Maximum | 125V |

Solder Process Data

| | |
|--|------------------------|
| Duration at Max. Process Temperature (seconds) | 10 |
| Lead-free Process Capability | Wave Capable (TH only) |
| Max. Cycles at Max. Process Temperature | 1 |
| Process Temperature max. C | 260 |

Material Info

Reference - Drawing Numbers

| | |
|-----------------------|--------------|
| Product Specification | PS-87831-027 |
| Sales Drawing | SD-87831-011 |

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